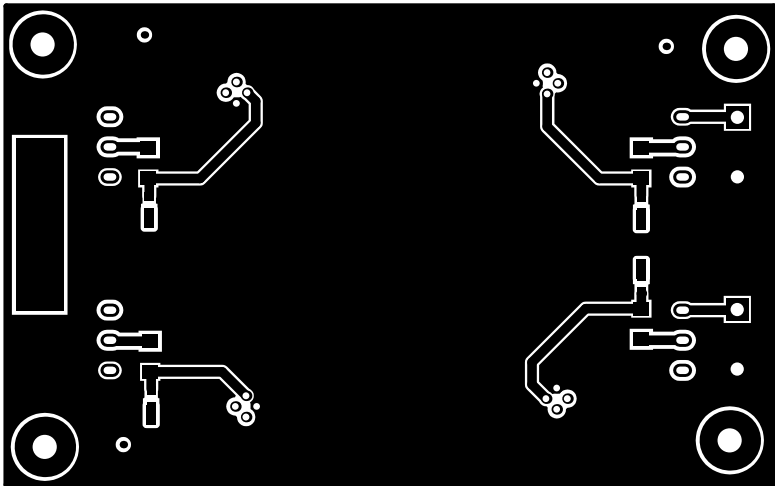
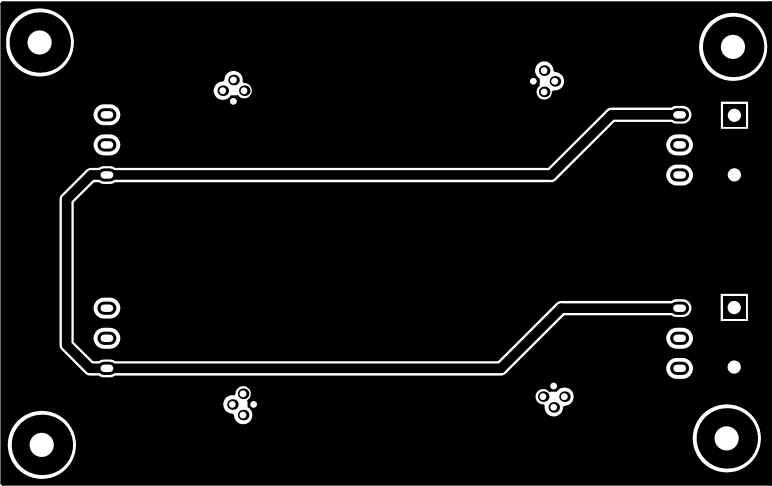


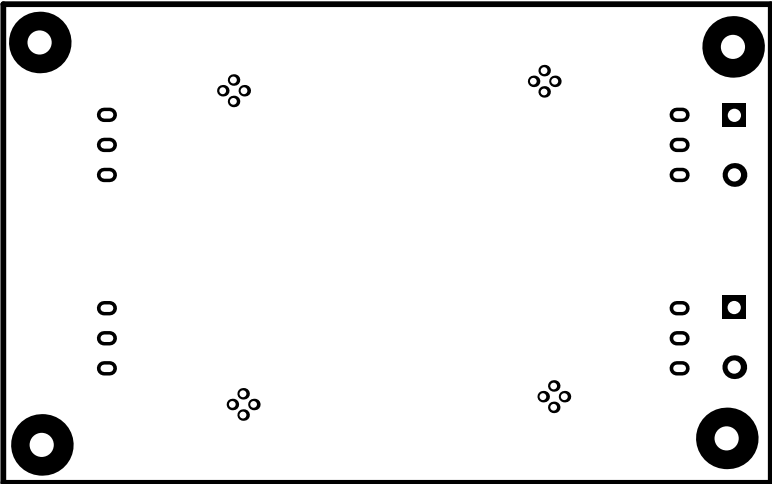
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Solder Information			
PLOT NAME = Top Solder Mask	GENERATED : 9/27/2013 4:23:45 PM	TEXAS INSTRUMENTS	



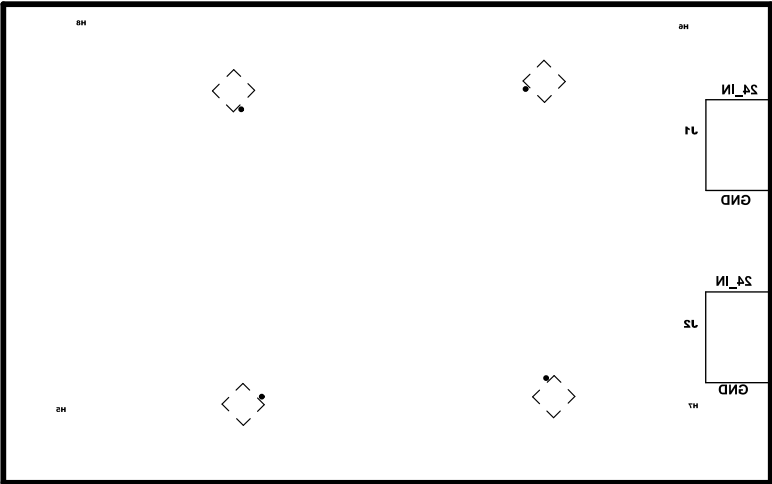
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Layer Bottom Layer Information			
PLOT NAME = Top Layer	GENERATED : 9/27/2013 4:23:45 PM	TEXAS INSTRUMENTS	



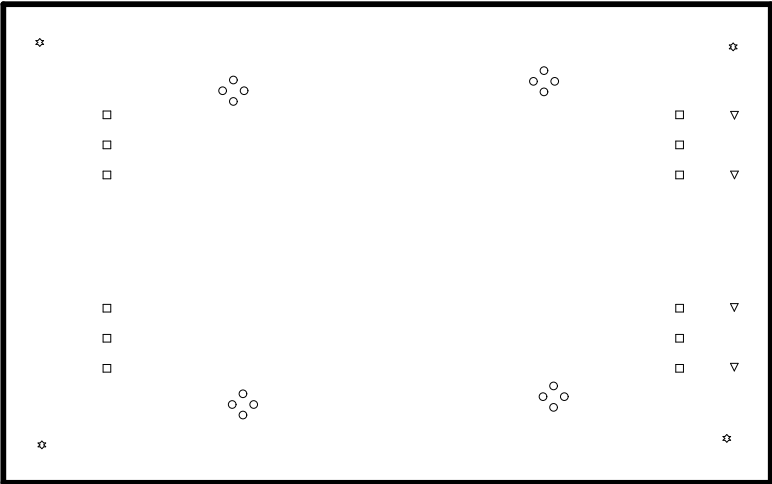
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/27/2013 4:23:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder Information			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/27/2013 4:23:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/27/2013 4:23:47 PM	TEXAS INSTRUMENTS	

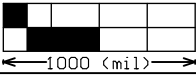
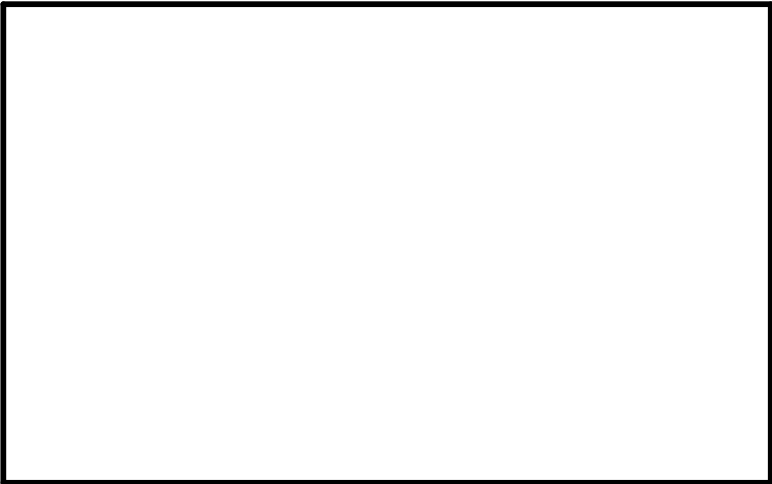


Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
○	16	35.433mil (0.9mm)			PTH	Round
▽	4	68.898mil (1.75mm)			PTH	Round
☆	4	125.984mil (3.2mm)			PTH	Round
□	12	39.37mil (1mm)	66.929mil (1.7mm)	27.559mil (0.7mm)	PTH	Slot
	36 Total					

Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.
Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	Drawing Information		
PLOT NAME = Drill Drawing	GENERATED : 9/27/2013 4:23:48 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0030	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = M21 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/27/2013 4:23:48 PM	TEXAS INSTRUMENTS	

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